

# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%

Characteristic	Symbol	S8KC	S8MC	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	800	1,000	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	560	700	V
Average Rectified Output Current @ T <sub>T</sub> = +75°C	lo		8.0	Α
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	2	200	А
Non-Repetitive Peak Forward Surge Current, 1.0ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	2	450	А
I <sup>2</sup> t Rating for fusing (t < 8.3ms)	l <sup>2</sup> t	,	166	A <sup>2</sup> S

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal (Note 6)	R <sub>θJT</sub>	10	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-65 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol		Value	Unit
Minimum Reverse Breakdown Voltage	@I <sub>R</sub> = 10μA	V <sub>(BR)R</sub>	S8MC S8KC	1,000 800	V
Maximum Forward Voltage	@ I <sub>F</sub> = 8.0A	V <sub>FM</sub>	0.985		V
Peak Reverse Current	@T <sub>A</sub> = +25°C @T <sub>A</sub> = +125°C	I <sub>RM</sub>	10 250		μA
Typical Reverse Recovery Time (Note 7)		Trr		2,700	ns
Typical Total Capacitance (Note 5)		CT		45	pF

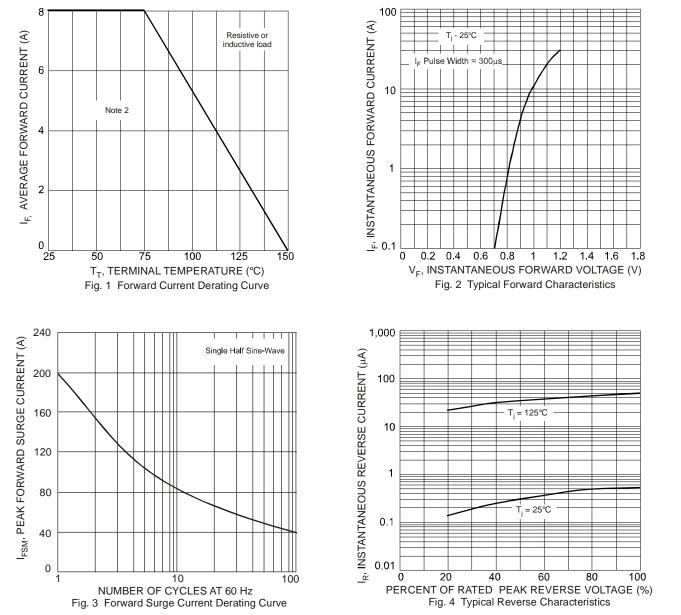
Note:

Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
Thermal resistance junction to terminal, device mounted on 100.5mm x 102.5mm x 1.7mm Cu plate heatsink.

7. Reverse Recovery Test Conditions: IF=0.5A, IR=1.0A, IRR=0.25A.

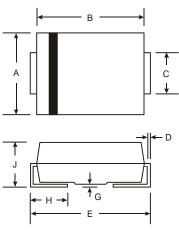


## S8KC - S8MC



### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

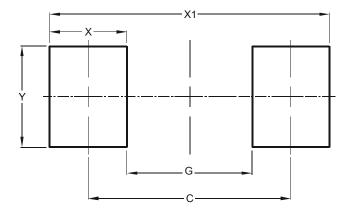


SMC		
Dim	Min	Max
Α	5.59	6.22
В	6.60	7.11
С	2.75	3.18
D	0.15	0.31
E	7.75	8.13
G	0.10	0.20
Н	0.76	1.52
J	2.00	2.50
All Dimensions in mm		



#### Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	6.80
G	4.40
Х	2.50
X1	9.40
Y	3.30

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